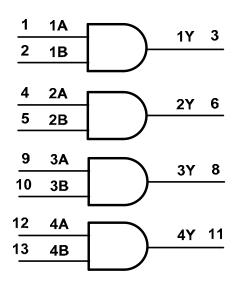


## **Pin Descriptions**

Pin Number	Pin Name	Description	
1	1A	Data Input	
2	1B	Data Input	
3	1Y	Data Output	
4	2A	Data Input	
5	2B	Data Input	
6	2Y	Data Output	
7	GND	Ground	
8	3Y	Data Output	
9	ЗA	Data Input	
10	3B	Data Input	
11	4Y	Data Output	
12	4A	Data Input	
13	4B	Data Input	
14	V <sub>CC</sub>	Supply Voltage	

# Logic Diagram



## **Function Table**

Inp	Inputs		
Α	A B		
L	L	L	
L	н	L	
н	L	L	
н	Н	Н	



Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	KV
ESD CDM	Charged Device Model ESD Protection	1	KV
ESD MM	Machine Model ESD Protection	200	V
V <sub>CC</sub>	Supply Voltage Range	-0.5 to 6.5	V
VI	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage applied to output in high impedance or I <sub>OFF</sub> state	-0.5 to 6.5	V
Vo	Voltage applied to output in high or low state	-0.3 to V <sub>CC</sub> +0.5	V
l <sub>IK</sub>	Input Clamp Current VI < 0	-50	mA
I <sub>OK</sub>	Output Clamp Current V <sub>O</sub> < 0	-50	mA
lo	Continuous output current	±50	mA
I <sub>CC</sub> , I <sub>GND</sub>	Continuous current through V <sub>CC</sub> or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T <sub>STG</sub>	Storage Temperature	-65 to +150	°C
P <sub>TOT</sub>	Total Power Dissipation	500	mW

# Absolute Maximum Ratings (Note 4) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Note: 4. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.

# Recommended Operating Conditions (Note 5) (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		1.65	5.5	V
VI	Input Voltage		0	5.5	V
<i>\</i> /	V <sub>O</sub> Output Voltage	Active Mode	0	V <sub>CC</sub>	V
VO		V <sub>CC</sub> = 0V; Power Down Mode	0	5.5	V
A ( / A ) /	Langel (magaziti a sila a su fall na fa	V <sub>CC</sub> = 1.65V to 2.7V		20	
Δt/ΔV	Input transition rise or fall rate	$V_{CC} = 2.7V$ to 5.5V		10	ns/V
T <sub>A</sub>	Operating free-air temperature		-40	+125	°C

Notes: 5. Unused inputs should be held at  $V_{\mbox{CC}}$  or Ground.



## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

		The second		$T_{A} = -40^{\circ}C$	C to +85°C	T <sub>A</sub> = -40°C	to +125°C		
Symbol	Parameter	Test Conditions	V <sub>cc</sub>	Min	Max	Min	Max	Unit	
			1.65V to 1.95V	0.65 X V <sub>CC</sub>		0.65 X V <sub>CC</sub>			
VIH	High-level		2.3V to 2.7V	1.7		1.6		V	
	Input Voltage		2.7V to 3.6V	2.0		2.0			
			1.65V to 1.95V		0.35 X V <sub>CC</sub>		0.35 X V <sub>CC</sub>		
VIL	Low-level	2.3V to 2.7V 0.7		0.7	V				
	input voltage		2.7V to 3.6V		0.8		0.8		
		I <sub>OH</sub> = -100μA	1.65V to 3.6V	V <sub>CC</sub> - 0.2		$V_{CC} - 0.3$			
		I <sub>OH</sub> = -4mA	1.65V	1.2					
N/	High Level	I <sub>OH</sub> = -8mA	2.3V	1.9					
V <sub>OH</sub>	Output Voltage	1. 10m	2.7V	2.2		2.05		V	
	voltage	I <sub>OH</sub> = -12mA	3.0V	2.3		2.1			
		I <sub>OH</sub> = -24mA	3.0V	2.2		2.0			
		I <sub>OH</sub> = 100μA	1.65V to 3.6V		0.2		0.3		
		$I_{OH} = 4mA$	1.65V		0.45		0.6		
V	High-level	I <sub>OH</sub> = 8mA	2.3V		0.70		0.85	V	
V <sub>OL</sub>	Output Voltage	1 10 m 4	2.7V		0.40		0.6	v	
	voltage	I <sub>OH</sub> = 12mA	3.0V		0.55		0.6		
		I <sub>OH</sub> =-24mA	3.0V		0.55		0.6		
lı	Input Current	V <sub>I</sub> =GND to 5.5V	3.6V		± 5		± 20	μA	
I <sub>OFF</sub>	Power Down Leakage Current	$V_1$ or $V_0 =$ 0V to 3.6V	0		10		20	μA	
Icc	Supply Current	$V_{I} = GND \text{ or } V_{CC}$ $I_{O}=0$	3.6V		10		40	μA	
ΔI <sub>CC</sub>	Additional Supply Current	One input at V <sub>CC</sub> – 0.6V Other at V <sub>CC</sub> or Gnd.	2.7V to 3.6V		500		5000	μA	



# **Switching Characteristics**

Symbol	Parameter	Test	V	T,	<sub>A</sub> = +25°C	;	-40°C to	⊳ +85°C	-40°C to	+125°C	Unit
Symbol	Parameter	Conditions	V <sub>cc</sub>	Min	Тур	Max	Min	Max	Min	Max	Unit
			1.65V to1.95V	1.0	5.0	9.3	1.0	9.8	1.0	11.3	
	Propagation Delay A <sub>N</sub> or B <sub>N</sub> Figure 1 to Y <sub>N</sub>	0	2.3V to 2.7V	1.0	2.9	6.4	1.0	6.9	1.0	9.0	
t <sub>PD</sub>		2.7V	1.0	3.0	4.6	1.0	4.8	1.0	6.0	ns	
	10 1		3V to 3.6V	1.0	2.6	3.9	1.0	4.1	1.0	5.5	
t <sub>SK(0)</sub>	Output Skew Time		3V to 3.6V					1.0		1.5	ns

## **Operating Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

	Parameter	Test Conditions	V <sub>cc</sub> = 1.8V Typ	V <sub>CC</sub> = 2.5V Typ	V <sub>cc</sub> = 3.3V Typ	Unit
C <sub>pd</sub>	Power dissipation capacitance per gate	f = 10 MHz	7.0	7.5	8.0	pF
Cı	Input Capacitance	$V_i = V_{CC} - or$ GND	4	4	4	pF

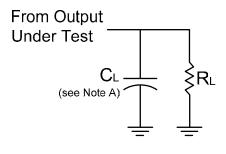
# Package Characteristics

Symbol	Parameter	Test Conditions	V <sub>cc</sub>	Min	Тур	Max	Unit
0	Thermal Resistance	SO-14	(Ninte C)		TBD		°C/W
$\theta_{JA}$	Junction-to-Ambient TSSOP-14 (Note 6)			159	C/vv		
Ο	Thermal Resistance	SO-14	() (a (a (a))		TBD		°C/W
$\theta_{\rm JC}$	Junction-to-Case	TSSOP-14	(Note 6)		25		C/VV

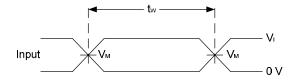
Note: 6. Test condition for SO-14 and TSSOP-14: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



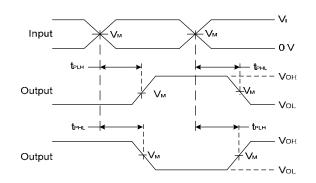
### **Parameter Measuement Information**



Vcc	Inputs		Inputs		D.
VCC	VI	t <sub>r</sub> /t <sub>f</sub>	V <sub>M</sub>	C∟	R∟
1.8V±0.15V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30pF	1ΚΩ
2.5V±0.2V	V <sub>CC</sub>	≤2ns	V <sub>CC</sub> /2	30pF	500Ω
2.7V	2.7V	≤2.5ns	1.5V	50pF	500Ω
3.3V±0.3V	2.7V	≤2.5ns	1.5V	50pF	500Ω



Voltage Waveform Pulse Duration



#### Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

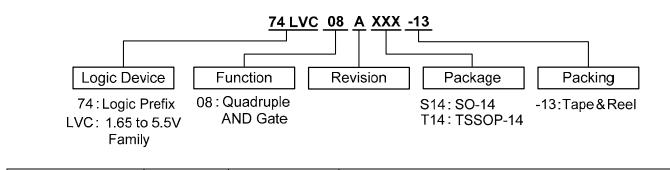
Notes: A. Includes test lead and test apparatus capacitance.

- B. All pulses are supplied at pulse repetition rate ≤ 10 MHz
- C. Inputs are measured separately one transition per measurement
- D.  $t_{\text{PLH}}$  and  $t_{\text{PHL}}$  are the same as  $t_{\text{PD}}$

#### Figure 1. Load Circuit and Voltage Waveforms



### **Ordering Information**

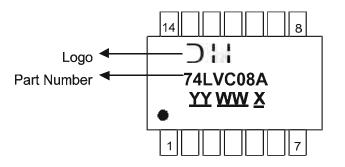


	Device	Package	Packaging	13" Tape	and Reel
	Device	Code	(Note 7)	Quantity	Part Number Suffix
Pb,	74LVC08AS14-13	S14	SO-14	2500/Tape & Reel	-13
Pb,	74LVC08AT14-13	T14	TSSOP-14	2500/Tape & Reel	-13

Notes: 7. The taping orientation and tape details can be found at http://www.diodes.com/datasheets/ap02007.pdf

## **Marking Information**

### (1) SO-14, TSSOP-14



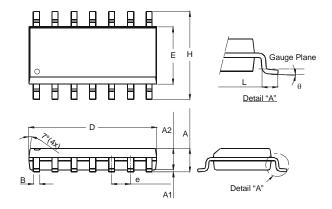
<u>YY</u> : Year : 08, 09,10~ <u>WW</u> : Week : 01~52; 52 represents 52 and 53 week <u>X</u> : Internal Code

Part Number	Package
74LVC08AS14	SO-14
74LVC08AT14	TSSOP-14



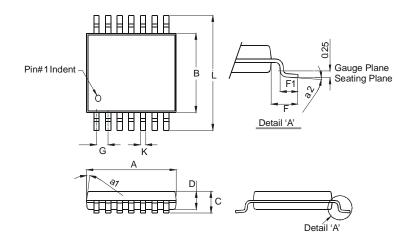
## Package Outline Dimensions (All dimensions in mm.)

### Package Type: SO-14



	SO-14					
Dim	Min	Max				
Α	1.47	1.73				
A1	0.10	0.25				
A2	1.45	Тур				
В	0.33	0.51				
D	8.53	8.74				
Е	3.80	3.99				
е	1.27	Тур				
Н	5.80	6.20				
L	0.38	1.27				
θ	0°	8°				
All Di	All Dimensions in mm					

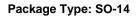
### Package Type: TSSOP-14

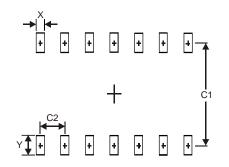


TSSOP-14		
Dim	Min	Max
a1	7° (4X)	
a2	0°	8°
Α	4.9	5.10
В	4.30	4.50
С		1.2
D	0.8	1.05
F	1.00 Тур	
F1	0.45	0.75
G	0.65 Typ	
К	0.19	0.30
L	6.40 Typ	
All Dimensions in mm		



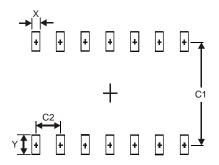
## Suggested Pad Layout





Dimensions	Value (in mm)
Х	0.60
Y	1.50
C1	5.4
C2	1.27

Package Type: TSSOP-14



Dimensions	Value (in mm)
Х	0.45
Y	1.45
C1	5.9
C2	0.65



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